19-4792; Rev 2; 5/04

EVALUATION KIT AVAILABLE

MXXIM +3.3V, 2.125Gbps/1.0625Gbps Fibre Channel Port Bypass ICs

General Description

The MAX3750/MAX3751 are +3.3V, Fibre Channel port bypass ICs that include a high-speed multiplexer and output buffer stage for hot swapping a storage device. These devices are optimized for use in a Fibre Channel arbitrated loop topology.

The MAX3750 has a 2.125Gbps data rate, while the MAX3751's data rate is 1.0625Gbps. Total power consumption (including output currents) is low: just 190mW for the MAX3750 and 180mW for the MAX3751. Low 10ps jitter makes these devices ideal for cascaded topologies. The output driver circuitry is tolerant of load mismatches commonly caused by board vias and inductive connectors. On-chip termination reduces external part count and simplifies board layout.

Applications

2.125Gbps Fibre Channel Arbitrated Loop

1.0625Gbps Fibre Channel Arbitrated Loop

Mass Storage Systems

RAID/JBOD Applications

Features

- Single +3.3V Supply
- Low Jitter: 10ps
- Low Power Consumption 190mW (MAX3750) 180mW (MAX3751)
- Large Output Signal Swing: >1000mVp-p
- Mismatch Tolerant Output Driver Stage
- 150Ω Differential On-Chip Termination on All Inputs
- 150Ω On-Chip Back Termination on All Output Ports

Ordering Information

Typical Application Circuit

PART	TEMP RANGE	PIN-PACKAGE
MAX3750CEE	0°C to +70°C	16 QSOP
MAX3750CEE†	0°C to +70°C	16 QSOP
MAX3751CEE	0°C to +70°C	16 QSOP

†Denotes lead-free package.

FC-AL 'K DRIVE FC-AL 'K DRIVE FC-AL DISK DRIVE SIS JISK TΧ RX TΧ RX ТΧ RX 83 3 5 LOUT+. Ż Ė OUT-Ē Ė -1U0. Ż Ė OUT+ DUT OUT /VI/IXI/VI ΜΛΧΙΜ ΜΛΧΙΜ C3 MAX3750 MAX3750 MAX3750 OUT+ OUT+ IN+ OUT+ IN+ IN-OUT-OUT-OUT-IN-١N IN-C4 C6 SFI Vcc SFI V_{CC} SFL V_{CC} GND GND GND 3 3V 3 3V 3 3V ÷ 는 MICROPROCESSOR C1 - C8 = 100 nFTHREE MAX3750/MAX3751s CASCADED IN AN FC-AL APPLICATION

Pin Configuration appears at end of data sheet.

M/XI/M

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.



ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{CC}....-0.5V to +5.0V Voltage at LOUT+, LOUT-,

OUT+, OUT-..... $(V_{CC} - 1.65V)$ to $(V_{CC} + 0.5V)$ Current Out of LOUT+, LOUT-, OUT+, OUT-..... $\pm 22mA$ Voltage at SEL, LIN+, LIN-, IN+, IN-....-0.5V to $(V_{CC} + 0.5V)$ Differential Voltage at (LIN+ - LIN-), (IN+ - IN-).... $\pm 2V$

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
16 QSOP (derate 8.3mW/°C above +70°C)	667mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	55°C to 150°C
Lead Soldering Temperature (soldering, 10s)	+300°C

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +3.6V, T_A = 0^{\circ}C \text{ to } +70^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.3V \text{ and } T_A = +25^{\circ}C.)$

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Current	MAX3750 (Note 1)		57	84	mA
	MAX3751 (Note 1)		54	78	
Data Input Voltage Swing	Total differential signal, peak-to-peak	200		2200	mV
Differential Input Impedance		132	150	172	Ω
Output Voltage at LOUT± and OUT±	150Ω load, total differential signal, peak-to-peak	1000		1600	mV
TTL Input Current		-10		10	μA
TTL Input Low		-0.3		0.8	V
TTL Input High		2		V _{CC} + 0.3	V

Note 1: Output currents included.

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +3.6V, T_A = 0^{\circ}C \text{ to } +70^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.3V \text{ and } T_A = +25^{\circ}C.)$

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
Data Bate	MAX3750		2.125		Gbps
	MAX3751		1.0625		
Data Input Voltage Swing	Total differential signal, peak-to-peak	200		2200	mV
Output Edge Speed	MAX3750			160	ps
IN± →OUT±, IN± →LOUT±	MAX3751			325	
Deterministic Jitter	MAX3750, peak-to-peak (Notes 2, 4)		10		ps
$IN \pm \rightarrow OUT \pm$, $IN \pm \rightarrow LOUT \pm$, $LIN \pm \rightarrow OUT \pm$	MAX3751, peak-to-peak (Notes 3, 4)		10		
Random Jitter	MAX3750, RMS (Note 2)			1.6	ps
$IN \pm \rightarrow OUT \pm$, $IN \pm \rightarrow LOUT \pm$, $LIN \pm \rightarrow OUT \pm$	MAX3751, RMS (Note 3)			1.6	
Prop Delay	MAX3750		300		
$IN \pm \rightarrow OUT \pm$, $IN \pm \rightarrow LOUT \pm$, $LIN \pm \rightarrow OUT \pm$	MAX3751		442		ps

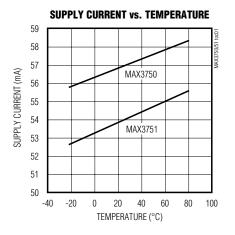
Note 2: Input t_R and $t_F < 150$ ps, 20% to 80%.

Note 3: Input $t_{\rm R}$ and $t_{\rm F} < 300$ ps, 20% to 80%.

Note 4: Deterministic jitter is measured with 20 bits of the k28.5 pattern (00111110101100000101).

Typical Operating Characteristics

(V_{CC} = 3.3V, T_A = $+25^{\circ}$ C, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION	
1, 4, 5, 8, 16	GND	Electrical Ground	
2	LOUT+	Noninverted Port Data Output	
3	LOUT-	Inverted Port Data Output	
6	OUT+	Noninverted Data Output	
7	OUT-	Inverted Data Output	
9	SEL	Select Input: SEL = Low: $IN \pm \rightarrow OUT \pm$ SEL = High: $LIN \pm \rightarrow OUT \pm$	
10	LIN-	Inverted Port Data Input	
11	LIN+	Noninverted Port Data Input	
12, 13	Vcc	Positive Supply Voltage	
14	IN-	Inverted Data Input	
15	IN+	Noninverted Data Input	

MAX3750/MAX3751

Circuit Description

A simplified block diagram of the single port bypass is shown in Figure 1. IN+ and IN- drive an input buffer (INBUFF) with 150 Ω of internal differential input termination. INBUFF drives an output buffer (LOBUFF) and an input to a multiplexer (MUX).

A low TTL input at SEL selects the signal path of INBUFF through MUX to the output buffer (OUTBUFF). When SEL has a high TTL logic level present the signal path is into LIBUFF, through MUX, to OUTBUFF.

Low-Frequency Cutoff

The low-frequency cutoff is determined by the input resistance and the coupling capacitor as illustrated by the following equation:

$f_{C} = 1 / (2\pi RC)$

In a typical system where R = 150 Ω and C = 100nF, resulting in fC = 10kHz.

Layout Techniques

The MAX3750/MAX3751 are high-frequency products. The performance of the circuit is largely dependent upon layout of the circuit board. Use a multilayer circuit board with dedicated ground and V_{CC} planes. Power supplies should be capacitively bypassed to the ground plane with surface-mount capacitors placed near the power-supply pins.

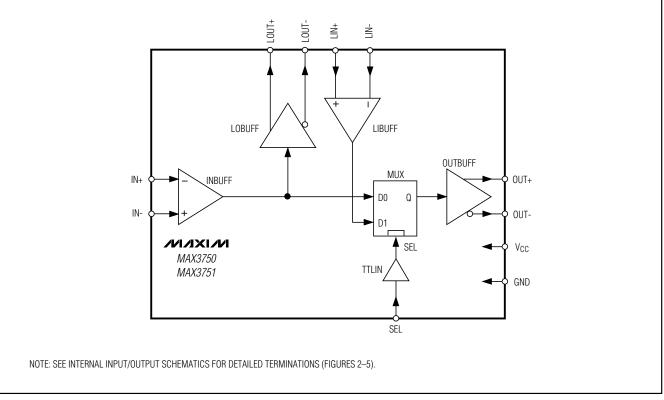


Figure 1. MAX3750/MAX3751 Block Diagram

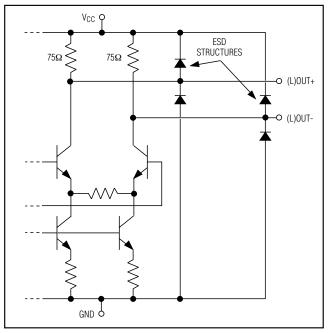


Figure 2. LOUT/OUT Pins Internal Input/Output Schematic

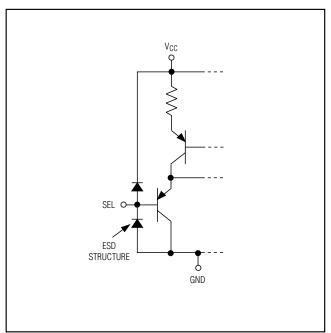


Figure 3. SEL Pin Internal Input/Output Schematic

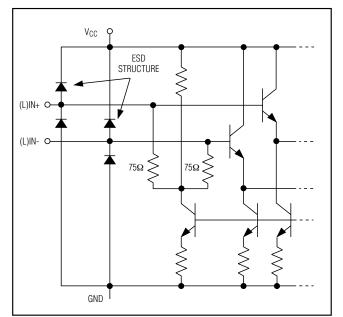


Figure 4. LIN/IN Pins Internal Input/Output Schematic

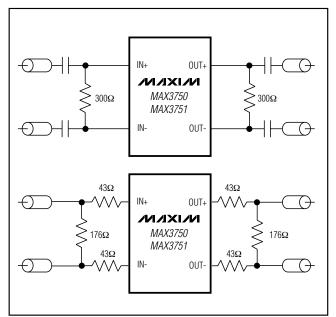
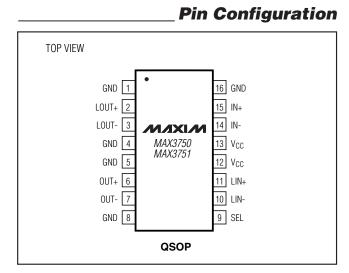
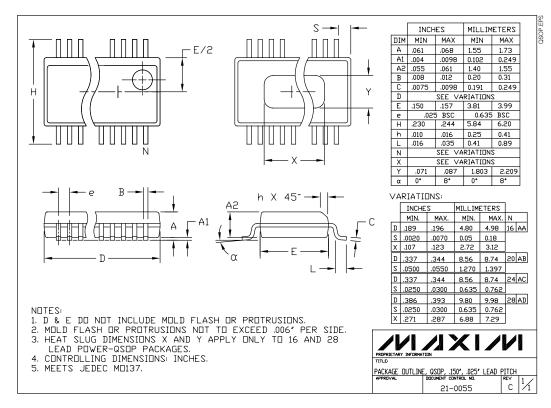


Figure 5. 50Ω Termination Applications



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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